



PD3S0230

SURFACE MOUNT SCHOTTKY BARRIER DIODE POWERDI323

Product Summary

| V _R | I _F | V _{F MAX} (V) | I _{R MAX} (μΑ) |
|----------------|----------------|------------------------|-------------------------|
| (V) | (mA) | @ +25°C | @ +25°C |
| 30 | 100 | 0.485 | 2.0 |

Description and Applications

This Schottky barrier rectifier has been designed to meet the Low forward voltage applications. It is ideally suited to use as:

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

Features and Benefits

- Low Forward Voltage Drop
- Fast Switching
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: POWERDI[®]323
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Band
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.005 grams (Approximate)







Bottom View

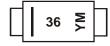
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|--------------------------|------------------|
| PD3S0230-7 | POWERDI [®] 323 | 3000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



36 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

| Year | 2011 | 2012 | 20 | 13 | 2014 | 2015 | 2016 | 2017 | 20 | 18 | 2019 | 2020 |
|-------|------|------|-----|-----|------|------|------|------|-----|-----|------|------|
| Code | Υ | Z | A | 4 | В | С | D | Е | | F | G | Н |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 30 | V |
| Continuous Forward Current | I _{FM} | 200 | mA |
| Repetitive Peak Forward Current | I _{FRM} | 300 | mA |
| Non-Repetitive Peak Forward Surge Current @ tp < 10ms | I _{FSM} | 600 | mA |

Thermal Characteristics

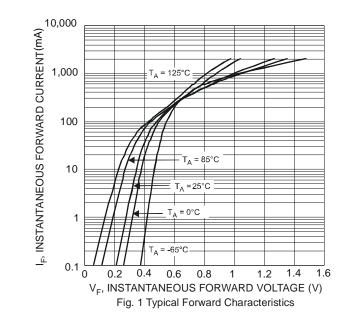
| Characteristic | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Thermal Resistance, Junction to Ambient Air (Note 5) | $R_{	hetaJA}$ | 242 | °C/W |
| Operating Temperature Range | TJ | -65 to +125 | °C |
| Storage Temperature Range | T _{STG} | -65 to +150 | °C |

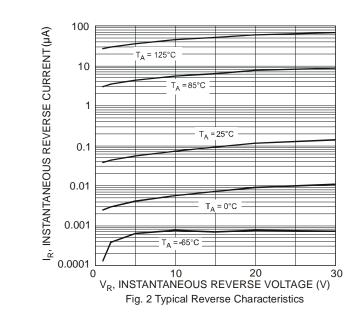
Electrical Characteristics (@ $T_A = \pm 25$ °C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|------------------------------------|-----------------|-----|---------------------------------|---------------------------------|------|--|
| Reverse Breakdown Voltage (Note 7) | $V_{(BR)R}$ | 30 | _ | _ | V | $I_R = 100 \mu A$ |
| Forward Voltage | V _F | _ | 217 280 350 400 485 | 240 320 400 500 800 | mV | I _F = 0.1mA I _F = 1mA I _F = 10mA I _F = 30mA I _F = 100mA |
| Leakage Current (Note 7) | I _R | _ | _ | 2.0 | μΑ | V _R = 25V |
| Total Capacitance | Ст | _ | 10.7 | _ | pF | $V_R = 1.0V, f = 1.0MHz$ |
| Reverse Recovery Time | t _{rr} | _ | _ | 5.0 | ns | I_F = 10mA through I_R = 10mA to I_R = 1.0mA, R_L = 100 Ω |

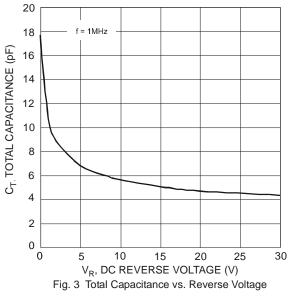
Notes:

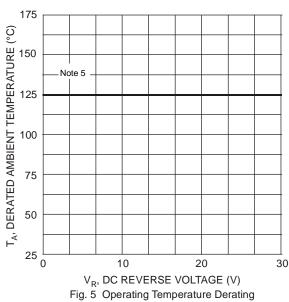
- 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com. $T_A = +25^{\circ}C$.
- 6. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 7. Short duration pulse test used to minimize self-heating effect.

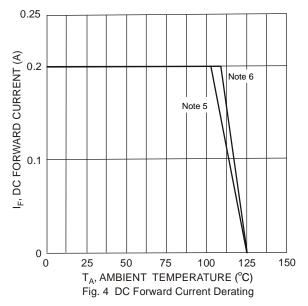


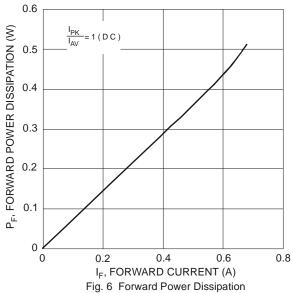








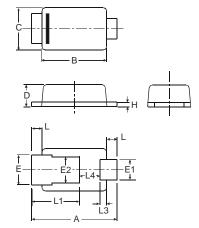




Package Outline Dimensions

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.

POWERDI®323



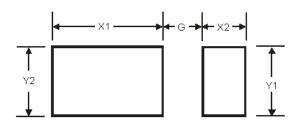
| POWERDI®323 | | | | | | | |
|----------------------|------|------|------|--|--|--|--|
| Dim | Min | Max | Тур | | | | |
| Α | 2.40 | 2.60 | 2.50 | | | | |
| В | 1.85 | 1.95 | 1.90 | | | | |
| С | 1.20 | 1.30 | 1.25 | | | | |
| D | 0.60 | 0.70 | 0.65 | | | | |
| Е | 0.78 | 0.98 | 0.88 | | | | |
| E1 | 0.50 | 0.70 | 0.60 | | | | |
| E2 | 0.60 | 1.00 | 0.80 | | | | |
| H | 0.08 | 0.18 | 0.13 | | | | |
| L | 0.20 | 0.40 | 0.30 | | | | |
| L1 | | | 1.40 | | | | |
| L3 | _ | | 0.20 | | | | |
| L4 | 0.40 | 0.80 | 0.60 | | | | |
| All Dimensions in mm | | | | | | | |



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/_files/datasheets/ap02001.pdf for the latest version.

POWERDI®323



| Dimensions | Value (in mm) |
|------------|---------------|
| G | 0.5 |
| X1 | 2.0 |
| X2 | 0.8 |
| Y1 | 0.8 |
| Y2 | 1.1 |

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